

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Yiping Zhao et al. : Art Unit:

Serial No.: To Be Assigned : Examiner:

Filed: Herewith

For: ULTRAFAST ALL-OPTICAL :

SWITCH USING CARBON :

NANOTUBE POLYMER :

COMPOSITES :



INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents Washington, D.C. 20231

SIR:

Pursuant to 37 C.F.R. §§ 1.97 and 1.98 and to the duty of disclosure set forth in 37 C.F.R. § 1.56, the Examiner in charge of the above-identified application is requested to consider and make of record the references listed on the PTO 1449 (R&P) submitted herewith. Copies of each of the listed references are also enclosed.

Although the information submitted herewith may be "material" to the Examiner's consideration of the subject application, this submission is not intended to constitute an admission that such information is "prior art" as to the claimed invention.

In accordance with 37 C.F.R. § 1.97(g), the filing of this Information Disclosure Statement shall not be construed to mean that a search has been made.

This Information Disclosure Statement is being filed together with the application. Therefore, no fee or certification is required. 37 C.F.R. § 1.97(b).

Respectfully submitted,

RATNER & PRESTIA

Kevin R. Casey, Reg. No. 32,117

Attorney for Applicants

KRC/kak

Enclosures: PTO Form 1449;

Copies of (16) References

Dated: February 12, 2002

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The Assistant Commissioner for Patents is hereby authorized to charge payment to Deposit Account No. 18-0350 of any fees associated with this communication.

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Date of Deposit: February 12, 2002

I hereby certify that this paper and fee is being deposited, under 37 C.F.R. § 1.10 and with sufficient postage, using the "Express Mail Post Office to Addressee" service of the United States Postal Service on the date indicated above and that the deposit is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.